



03-22-04

Express Mail No.: EV 371 773 196 US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Li, Yuan Confirmation No.: 1808
Serial No.: 10/616,858 Art Unit: 2814
Filed: July 9, 2003 Examiner: Ha, Nathan W.
For: Low Warpage Flip Chip Package Attorney Docket No: 60889-086
Solution - Channel Heat Spreader

FEE TRANSMITTAL SHEET

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The fee required to be filed with the accompanying amendment of even date herewith concerning the above-identified application has been estimated to be \$0.00.

The claim amendment fee has been estimated as shown below:

(Col. 1)		(Col. 2)		(Col. 3)		<input type="checkbox"/> SMALL ENTITY	<input checked="" type="checkbox"/> OTHER THAN A SMALL ENTITY		
CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID		PRESENT EXTRA		RATE	ADDIT. FEE	OR	ADDIT. FEE
TOTAL	21	MINUS	26	0	x 9	\$		x 18	\$ 0.00
INDEP.	2	MINUS	3	0	x 43	\$		x 86	\$ 0.00
<input type="checkbox"/> FIRST PRESENTATION OF MULTIPLE DEP. CLAIM						\$		\$	0.00
TOTAL						\$	OR	TOTAL	\$ 0.00

Please charge the required fee to Morgan, Lewis & Bockius LLP Deposit Account No. 50-0310 (order no. 60889-086). A copy of this sheet is enclosed.

Date: March 19, 2004

Respectfully submitted,

Francis E. Morris

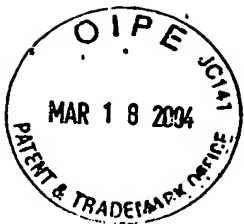
(Reg.No.24,615)

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(650) 493-4935



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Group Art Unit: 2814

Filed: July 9, 2003

Examiner: Ha, Nathan W.

For: Low Warpage Flip Chip Package
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Attorney Docket No.: 060889-086 (formerly
9818-086-999)

RESPONSE TO OFFICE ACTION MAILED DECEMBER 19, 2003

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant submits the following amendments and remarks in response to the Office
Action mailed December 19, 2003, in the above-identified application.